



MICROCHIP

PIC18(L)F27/47K40

28/40/44-Pin, Low-Power, High-Performance Microcontrollers with XLP Technology

Description

These PIC18(L)F27/47K40 microcontrollers feature analog, core independent peripherals and communication peripherals, combined with eXtreme Low-Power (XLP) technology for a wide range of general purpose and low-power applications. These 28/40/44-pin devices are equipped with a 10-bit ADC with Computation (ADCC) automating Capacitive Voltage Divider (CVD) techniques for advanced touch sensing, averaging, filtering, oversampling and performing automatic threshold comparisons. They also offer a set of core independent peripherals such as Complementary Waveform Generator (CWG), Windowed Watchdog Timer (WWDT), Cyclic Redundancy Check (CRC)/Memory Scan, Zero-Cross Detect (ZCD) and Peripheral Pin Select (PPS) providing for increased design flexibility and lower system cost.

Core Features

- C Compiler Optimized RISC Architecture
- Operating Speed:
 - DC – 64 MHz clock input over the full V_{DD} range
 - 62.5 ns minimum instruction cycle
- Programmable 2-Level Interrupt Priority
- 31-Level Deep Hardware Stack
- Three 8-Bit Timers (TMR2/4/6) with Hardware Limit Timer (HLT)
- Four 16-Bit Timers (TMR0/1/3/5)
- Low-Current Power-on Reset (POR)
- Power-up Timer (PWRT)
- Brown-out Reset (BOR)
- Low-Power BOR (LPBOR) Option
- Windowed Watchdog Timer (WWDT):
 - Watchdog Reset on too long or too short interval between watchdog clear events
 - Variable prescaler selection
 - Variable window size selection
 - All sources configurable in hardware or software

Memory

- 128K Bytes Program Flash Memory
- 3728 Bytes Data SRAM Memory

PIC18(L)F27/47K40

- 1024 Bytes Data EEPROM
- Programmable Code Protection
- Direct, Indirect and Relative Addressing modes

Operating Characteristics

- Operating Voltage Ranges:
 - 1.8V to 3.6V (PIC18LF27/47K40)
 - 2.3V to 5.5V (PIC18F27/47K40)
- Temperature Range:
 - Industrial: -40°C to 85°C
 - Extended: -40°C to 125°C

Power-Saving Operation Modes

- Doze: CPU and Peripherals Running at Different Cycle Rates (typically CPU is lower)
- Idle: CPU Halted While Peripherals Operate
- Sleep: Lowest Power Consumption
- Peripheral Module Disable (PMD):
 - Ability to selectively disable hardware module to minimize active power consumption of unused peripherals
- Extreme Low-Power mode (XLP)
 - Sleep: 500 nA typical @ 1.8V
 - Sleep and Watchdog Timer: 900 nA typical @ 1.8V

eXtreme Low-Power (XLP) Features

- Sleep mode: 50 nA @ 1.8V, typical
- Windowed Watchdog Timer: 500 nA @ 1.8V, typical
- Secondary Oscillator: 500 nA @ 32 KHz
- Operating Current:
 - 8 μ A @ 32 KHz, 1.8V, typical
 - 32 μ A/MHz @ 1.8V, typical

Digital Peripherals

- Complementary Waveform Generator (CWG):
 - Rising and falling edge dead-band control
 - Full-bridge, half-bridge, 1-channel drive
 - Multiple signal sources
- Capture/Compare/PWM (CCP) modules:
 - Two CCPs
 - 16-bit resolution for Capture/Compare modes
 - 10-bit resolution for PWM mode
- 10-Bit Pulse-Width Modulators (PWM):

PIC18(L)F2747K40

- Two 10-bit PWMs
- Serial Communications:
 - Two Enhanced USART (EUSART) with Auto-Baud Detect, Auto-wake-up on Start, RS-232, RS-485, LIN compatible
 - SPI
 - I²C, SMBus and PMBus™ compatible
- Up to 35 I/O Pins and One Input Pin:
 - Individually programmable pull-ups
 - Slew rate control
 - Interrupt-on-change on all pins
 - Input level selection control
- Programmable CRC with Memory Scan:
 - Reliable data/program memory monitoring for Fail-Safe operation (e.g., Class B)
 - Calculate CRC over any portion of Flash or EEPROM
 - High-speed or background operation
- Hardware Limit Timer (TMR2/4/6+HLT):
 - Hardware monitoring and Fault detection
- Peripheral Pin Select (PPS):
 - Enables pin mapping of digital I/O
- Data Signal Modulator (DSM)

Analog Peripherals

- 10-Bit Analog-to-Digital Converter with Computation (ADC²):
 - 35 external channels
 - Conversion available during sleep
 - Four internal analog channels
 - Internal and external trigger options
 - Automated math functions on input signals:
 - Averaging, filter calculations, oversampling and threshold comparison
 - 8-bit hardware acquisition timer
- Hardware Capacitive Voltage Divider (CVD) Support:
 - 8-bit precharge timer
 - Adjustable sample and hold capacitor array
 - Guard ring digital output drive
- Zero-Cross Detect (ZCD):
 - Detect when AC signal on pin crosses ground
- 5-Bit Digital-to-Analog Converter (DAC):
 - Output available externally
 - Programmable 5-bit voltage (% of V_{DD} , $[V_{Ref+} - V_{Ref-}]$ FVR)
- Internal connections to comparators and ADC
- Two Comparators (CMP):
 - Four external inputs
 - External output via PPS

PIC18(L)F2747K40

- Fixed Voltage Reference (FVR) Module:
 - 1.024V, 2.048V and 4.096V output levels
 - Two buffered outputs: One for DAC/CMP and one for ADC

Clocking Structure

- High-Precision Internal Oscillator Block (HFINTOSC):
 - Selectable frequencies up to 64 MHz
 - ±1% at calibration
- 32 kHz Low-Power Internal Oscillator (LFINTOSC)
- External 32 kHz Crystal Oscillator (SOSC)
- External High-frequency Oscillator Block:
 - Three crystal/resonator modes
 - Digital Clock Input mode
 - 4x PLL with external sources
- Fail-Safe Clock Monitor:
 - Allows for safe shutdown if external clock stops
- Oscillator Start-up Timer (OST)

Programming/Debug Features

- In-Circuit Serial Programming™ (ICSP™) via Two Pins
- In-Circuit Debug (ICD) with Three Breakpoints via Two Pins
- Debug Integrated On-Chip

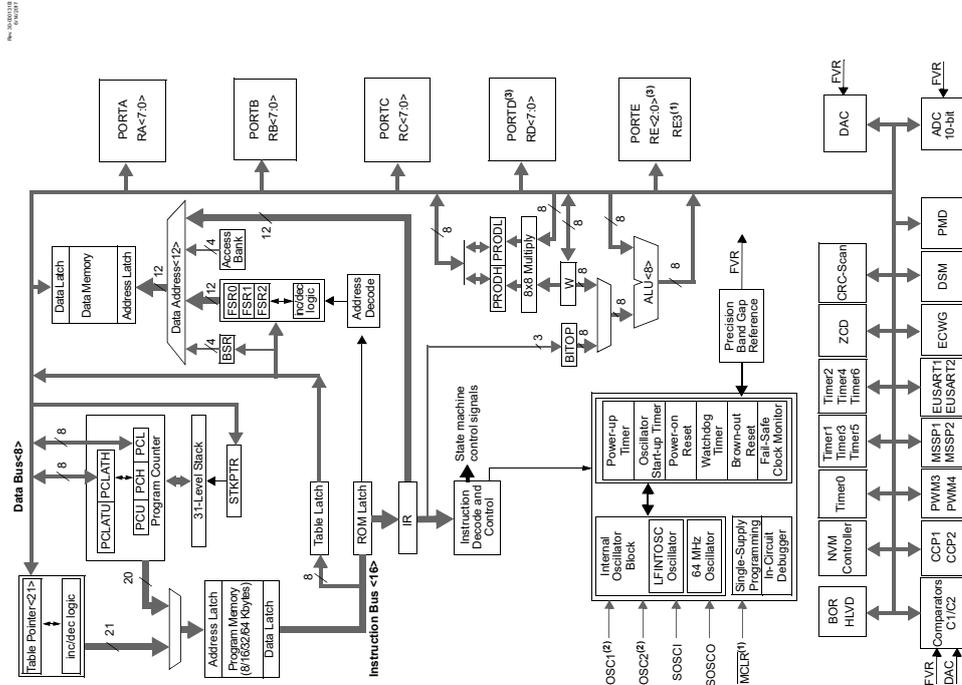
PIC18(L)F2747K40 Family Types

Table 1. Devices included in this data sheet

Device	Program Memory Flash (bytes)	Data SRAM (bytes)	Data EEPROM (bytes)	I/O Pins	16-bit Timers	Comparators	10-bit ADC ² with Computation (ch)	5-bit DAC	Zero-Cross Detect	CCP/10-bit PWM	CWG	SMT	Low Voltage Detect (LVD)	8-bit TMR with HLT	Windowed Watchdog Timer	CRC with Memory Scan	EUSART	I ² C/SPI	PPS	Peripheral Module Disable	Temperature Indicator	Debug (1)	
PIC18(L)F27K40	128k	3615	1024	25	4	2	24	1	1	2/2	1	0	1	3	Y	Y	2	2	2	Y	Y	Y	1
PIC18(L)F47K40	128k	3615	1024	36	4	2	35	1	1	2/2	1	0	1	3	Y	Y	2	2	2	Y	Y	Y	1

PIC18(L)F27/47K40 Device Overview

Figure 1-1. PIC18(L)F27/47K40 Family Block Diagram



- Note 1: RES is only available when MCLR functionality is disabled.
- Note 2: OSC1/CLKIN and OSC2/CLKOUT are only available in select oscillator modes.
- Note 3: PORTD and PORTE<2:0> not implemented on 28-pin devices.

PIC18(L)F27/47K40 Memory Organization

Figure 10-1. Program and Data Memory Map

Address	PIC18(L)F27/47K40	PIC18(L)F25/45K40	PIC18(L)F55K40	PIC18(L)F65K40	PIC18(L)F84K40	PIC18(L)F27/47K40
Note 1	Device					
00 0000h to 00 0008h	Stack (31 Levels)					
00 0008h to 00 0018h	Reset Vector					
00 0018h to 00 007Ah	Interrupt Vector High					
00 007Ah to 00 3FFFh	Interrupt Vector Low					
00 3FFFh to 00 4000h	Program Flash Memory (8 KW)	Program Flash Memory (16 KW)	Program Flash Memory (16 KW)	Program Flash Memory (32 KW)	Program Flash Memory (64 KW)	Program Flash Memory (64 KW)
00 4000h to 00 7FFFh	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾
00 7FFFh to 01 0000h	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾
01 0000h to 01 EFFFh	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾
01 EFFFh to 20 0000h	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾	Not Present ⁽²⁾
20 0000h to 20 00FEh	User IDs (8 Words) ⁽³⁾					
20 00FEh to 2E FFFFh	Reserved					
2E FFFFh to 30 0000h	Configuration Words (6 Words) ⁽³⁾					
30 0000h to 30 000Ch	Reserved					
30 000Ch to 30 FFFFh	Reserved					
30 FFFFh to 31 0000h	Data EEPROM (256 Bytes)					
31 0000h to 31 01FFFh	Unimplemented					
31 01FFFh to 30 FFFFh	Data EEPROM (1024 Bytes)					
30 FFFFh to 3F FFFFh	Reserved					
3F FFFFh to 3F FFFDh	Revision ID (1 Word) ⁽⁴⁾					
3F FFFDh to 3F FFFCh	Device ID (1 Word) ⁽⁴⁾					

- Note 1: The stack is a separate SPAM panel, apart from all user memory panels.
- Note 2: The addresses do not roll over. The region is read as '0'.
- Note 3: Not code-protected.
- Note 4: Device/Revision IDs are hard-coded in silicon.

PIC18(L)F27/47K40
Memory Organization

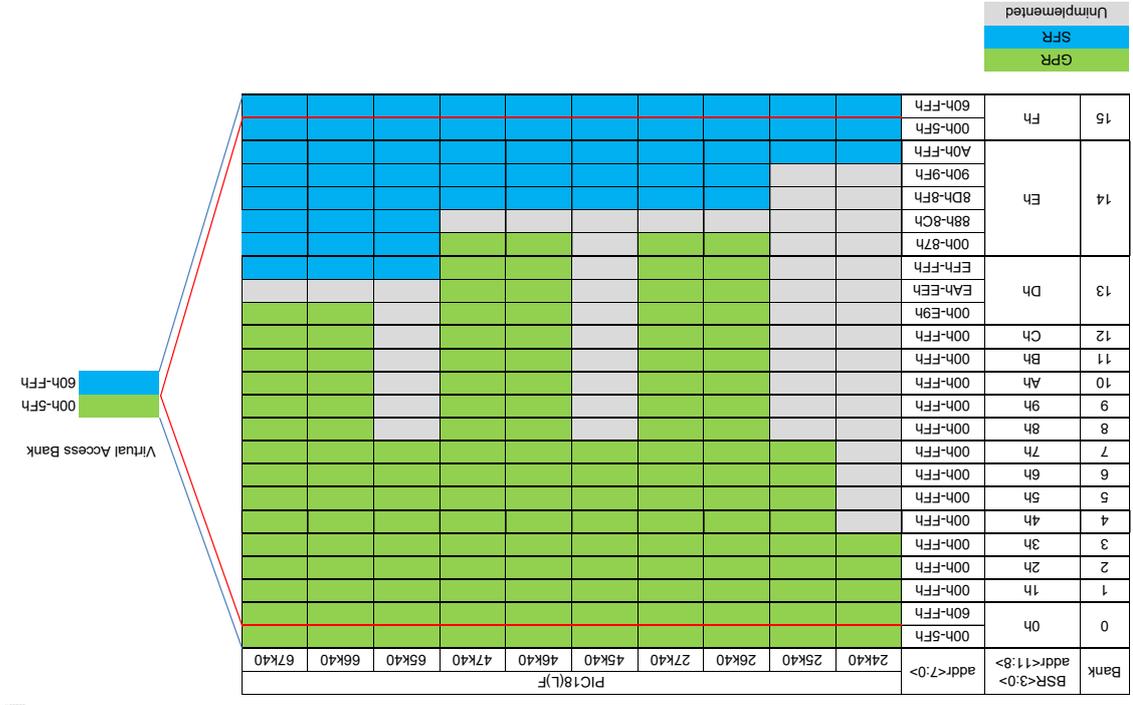


Figure 10-8. Data Memory Map